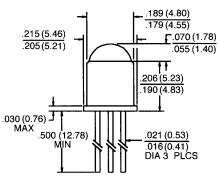
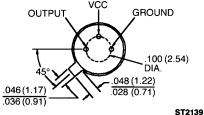
### **OPTOLOGIC™**



# QSA156/157/158/159

## **PACKAGE DIMENSIONS**





## DESCRIPTION

The QSA15X family are OPTOLOGIC™ ICs which feature a Schmitt trigger at output which provides hysteresis for noise immunity and pulse shaping. The basic building block of this IC consists of a photodiode, a linear amplifier, voltage regulator, Schmitt trigger and four output options. The TTL/LSTTL compatible output can drive up to ten TTL loads over supply currents from 4.5 to 16.0 volts. The monolithic die is packaged in a narrow angle, hermetically sealed, TO-18 metal can package.

## **FEATURES**

- High noise immunity.
- Direct TTL/LSTTL interface.
- Hermetically sealed package.
- Reception angle of ±12°.





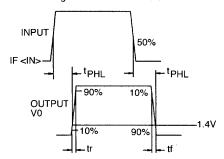
ABSOLUTE MAXIMUM RATINGS (TA = 25°C Unio	ess Otherwise Specified)
Supply Voltage, V <sub>cc</sub>	
Storage Temperature	
Operating Temperature	
Lead Temperature (Iron)	240°C for 5 sec. (2.3,4,5)
Lead Temperature (Flow)	260°C for 10 sec. (2.3.5)
Power Dissipation	250 mW <sup>(1)</sup>
Duration of Output short to V <sub>cc</sub>	
Voltage at Output	
Sinking Current	
Sourcing Current (QSA156, QSA157)	
Irradiance	

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS
Operating Supply Voltage	V <sub>cc</sub>	4.5		16.0	V	
Positive Going Threshold Irradiance <sup>(6)</sup>	Ee (+)	0.025		0.250	mW/cm²	T <sub>A</sub> = 25°C
Hysteresis Ratio	Ee(+)/Ee(-)	1.10		2.00		
Supply Current	I <sub>cc</sub>	_		12.0	mA	Ee = 0 or .3 mW/cm <sup>2</sup> (6)
Peak to peak ripple which will cause false triggering				2.00	V	f = DC to 50 MHZ
QSA156 (BUFFER TOTE	M POLE)					
High Level Output Voltage	$V_{OH}$	$V_{\text{cc}}-2.1$		_	V	Ee = .3 mW/cm <sup>2</sup> , $I_{OH} = -1.0 \text{ mA}^{(6)}$
Low Level Output Voltage	V <sub>oL</sub>	_		0.40	V	$Ee = 0, I_{OL} = 16 \text{ mA}$
QSA157 (INVERTER TO						
High Level Output Voltage	V <sub>OH</sub>	V <sub>cc</sub> - 2.1			V	$Ee = 0, I_{OH} = -1.0 \text{ mA}$
Low Level Output Voltage	$V_{oL}$	_		0.40	V	$Ee = .3 \text{ mW/cm}^2$ , $I_{OL} = 16 \text{ mA}^{(6)}$
QSA158 (BUFFER OPEN	COLLECTOR	l)				
High Level Output Current	I <sub>OH</sub>	_		100	$\muA$	$Ee = .3 \text{ mW/cm}^2$ , $V_{OH} = 30 V^{(6)}$
Low Level Output Voltage	V <sub>oL</sub>	_		0.40	٧	$Ee = 0, I_{OL} = 16 \text{ mA}$
QSA159 (INVERTER OP	EN COLLECTO	OR)				
High Level Output Current	I <sub>OH</sub>	<b>'</b> —		100	$\muA$	$Ee = 0, V_{OH} = 30 V$
Low Level Output Voltage	V <sub>oL</sub>	_		0.40	V	Ee = .3 mW/cm², I <sub>OI</sub> = 16 mA <sup>(6)</sup>

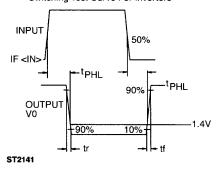


ELECTRICAL CHARACTERISTICS (T <sub>A</sub> = -40°C to +85°C) (V <sub>cc</sub> = 4.5 to 16 volts)								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS	TEST CONDITIONS		
QSA156, QSA157								
Output rise, fall times	tr, tf	_		70	nS	Ee=0 or .3 mW/cm², f=10K HZ		
Propagation delay	tphl, tplh		6.0		μS	DC=50%, R <sub>L</sub> =10 TTL loads		
QSA158, QSA159								
Output rise, fall times	tr, tf	_		100	nS	Ee=0 or .3 mW/cm², f=10K HZ DC=50%, R <sub>L</sub> =300Ω <sup>(6)</sup>		
Propagation delay	tphi, tplh		6.0		μS			

### Switching Test Curve For Buffers



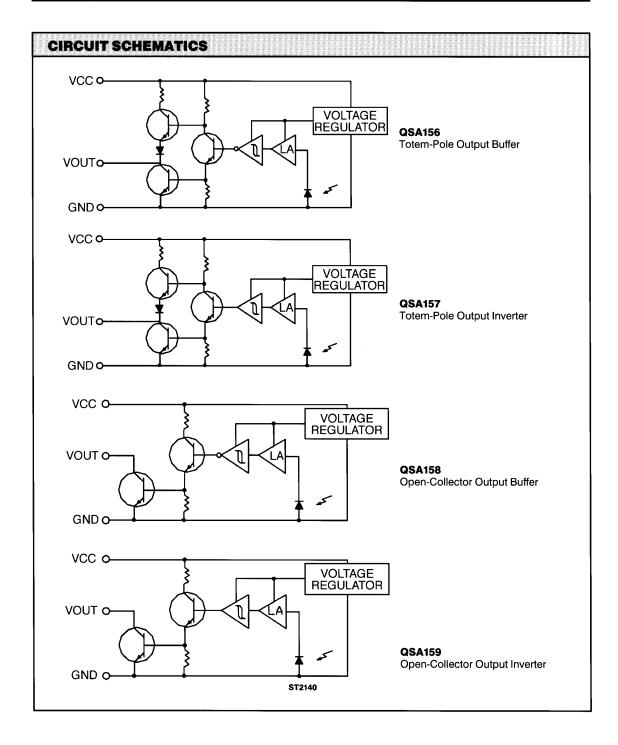
### Switching Test Curve For Inverters



## NOTES

- 1. Derate power dissipation linearly 2.50 mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or Isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron tip ¼ε" (1.6 mm) minimum from housing.
- 5. As long as leads are not under any stress or spring tension.
- 6. Irradiance measurements are made with an AlGaAs LED emitting light at a peak wavelength of 880 nm.









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